

REVISIONS			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Add device 02. Editorial changes throughout. Change drawing CAGE to 67268.	90-03-07	W. Heckman
B	Changes IAW NOR 5962-R023-99. - ljs	99-01-27	Raymond Monnin
C	Update to reflect latest changes in format and requirements. Editorial changes throughout. -les	01-11-28	Raymond Monnin
D	Update drawing to current requirements. Editorial changes throughout. - gap	09-03-12	Robert M. Heber

CURRENT CAGE CODE 67628

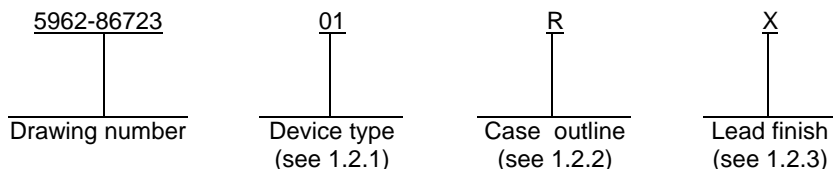
The original first sheet of this drawing has been replaced.

REV																			
SHEET																			
REV	D	D																	
SHEET	15	16																	
REV STATUS	REV		D	D	D	D	D	D	D	D	D	D	D	D	D	D	D	D	D
OF SHEETS	SHEET		1	2	3	4	5	6	7	8	9	10	11	12	13	14			
PMIC N/A	PREPARED BY David W. Queenan				DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990 http://www.dsccl.dla.mil														
STANDARD MICROCIRCUIT DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A	CHECKED BY D. A. DiCenzo																		
	APPROVED BY N. A. Hauck				MICROCIRCUIT, DIGITAL, BIPOLAR, OCTAL, 3-STATE, BIDIRECTIONAL, BUS TRANSCEIVER, MONOLITHIC SILICON														
	DRAWING APPROVAL DATE 87-02-09																		
	REVISION LEVEL D				SIZE A	CAGE CODE 14933	5962-86723												
				SHEET 1 OF 16															

1. SCOPE

1.1 Scope. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



1.2.1 Device type(s). The device type(s) identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	2947	Octal, 3-state, bi-directional, bus transceivers noninverting
02	2946	Octal, 3-state, bi-directional, bus transceivers inverting

1.2.2 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
R	GDIP1-T20 or GDIP2-T20	20	Dual-in-line package
2	CQCC1-N20	20	Square chip carrier

1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.

1.3 Absolute maximum ratings.

Supply voltage	-0.5 V dc to +7.0 V dc
Input voltage range	-1.5 V dc to +5.5 V dc
Storage temperature range	-65°C to +150°C
Maximum power dissipation (P _D) per device ^{1/}	775 mW
Lead temperature (soldering, 10 seconds)	+300°C
Thermal resistance, junction-to-case (θ _{JC})	See MIL-STD-1835
Junction temperature (T _J)	+175°C

1.4 Recommended operating conditions.

Supply voltage range (V _{CC})	+4.5 V dc to 5.5 V dc
Minimum high level input voltage (V _{IH})	2.0 V dc
Maximum low level input voltage (V _{IL})	0.7 V dc
Ambient operating temperature range (T _A)	-55°C to +125°C

^{1/} Must withstand the added P_D due to short circuit test (e.g. I_{OS}).

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2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.
 MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.
 MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <http://assist.daps.dla.mil/quicksearch/> or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Truth table. The truth table shall be as specified on figure 2.

3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.

3.2.5 Test circuit and switching waveforms. The test circuit and switching waveforms shall be as specified on figures 4 through 6.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full ambient operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

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3.5 Marking. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.

3.5.1 Certification/compliance mark. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.

3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DSCC-VA shall be required for any change that affects this drawing.

3.9 Verification and review. DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C unless otherwise specified		Group A subgroups	Device type	Limits		Unit
						Min	Max	
High level output voltage, A ₀ - A ₇	V _{OH1}	V _{CC} = 4.5 V, T/R̄ = 0.8 V, CD = 0.7 V	I _{OH} = -0.4 mA	1, 2, 3	All	3.35		V
			I _{OH} = -3.0 mA	1, 2, 3	All	2.7		V
High level output voltage, B ₀ - B ₇	V _{OH2}	V _{CC} = 4.5 V, T/R̄ = 2.0 V, CD = 0.7 V	I _{OH} = -0.4 mA	1, 2, 3	All	3.35		V
			I _{OH} = -5.0 mA	1, 2, 3	All	2.7		V
			I _{OH} = -10 mA	1, 2, 3	All	2.4		V
Low level output voltage, A ₀ - A ₇	V _{OL1}	V _{CC} = 4.5 V, T/R̄ = 0.8 V, CD = 0.7 V, I _{OL} = 12 mA		1, 2, 3	All		0.4	V
Low level output voltage, B ₀ - B ₇	V _{OL2}	V _{CC} = 4.5 V, T/R̄ = 2.0 V, CD = 0.7 V	I _{OL} = 20 mA	1, 2, 3	All		0.4	V
			I _{OL} = 48 mA	1, 2, 3	All		0.55	V
Input clamp voltage, A ₀ - A ₇ and B ₀ - B ₇	V _{IC1}	V _{CC} = 4.5 V, CD = 2.0 V, I _{IN} = -12 mA		1, 2, 3	All		-1.5	V
Input clamp voltage, CD, T/R̄	V _{IC2}	V _{CC} = 4.5 V, I _{IN} = -12 mA		1, 2, 3	All		-1.5	V
High level input current, A ₀ - A ₇	I _{IH1}	V _{CC} = 5.5 V, T/R̄ = 2.0 V, CD = 0.7 V, V _{IN} = 2.7 V		1, 2, 3	All		80	μA
High level input current, B ₀ - B ₇	I _{IH2}	V _{CC} = 5.5 V, T/R̄ = CD = 0.7 V, V _{IN} = 2.7 V		1, 2, 3	All		80	μA
High level input current, CD, T/R̄	I _{IH3}	V _{CC} = 5.5 V, V _{IN} = 2.7 V		1, 2, 3	All		20	μA
High level input current, A ₀ - A ₇ , B ₀ - B ₇	I _{IH4}	V _{CC} = 5.5 V, CD = 2.0 V, V _{IN} = 5.5 V		1, 2, 3	All		1	mA
High level input current, T/R̄, CD	I _{IH5}	V _{CC} = 5.5 V, V _{IN} = 5.5 V		1, 2, 3	All		1	mA
Low level input current, A ₀ - A ₇	I _{IL1}	V _{CC} = 5.5 V, T/R̄ = 2.0 V, CD = 0.7 V, V _{IN} = 0.4 V		1, 2, 3	All		-200	μA
Low level input current, B ₀ - B ₇	I _{IL2}	V _{CC} = 5.5 V, T/R̄ = 0.7 V, CD = 0.7 V, V _{IN} = 0.4 V		1, 2, 3	All		-200	μA
Low level input current, CD, T/R̄	I _{IL3}	V _{CC} = 5.5 V, V _{IN} = 0.4 V		1, 2, 3	All		-250	μA

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C unless otherwise specified		Group A subgroups	Device type	Limits		Unit
						Min	Max	
Short circuit output current, A ₀ - A ₇	I _{OS1}	V _{CC} = 5.5 V, T/ \bar{R} = 0.8 V, CD = 0.7 V, V _{OUT} = 0.0 V <u>1/</u>		1, 2, 3	All	-10	-75	mA
Short circuit output current, B ₀ - B ₇	I _{OS2}	V _{CC} = 5.5 V, T/ \bar{R} = 2.0 V, CD = 0.7 V, V _{OUT} = 0.0 V <u>1/</u>		1, 2, 3	All	-25	-150	mA
Functional tests		See 4.3.1c		7, 8	All			
Off state output current high	I _{OZH}	V _{CC} = 5.5 V, CD = 2.0 V, V _{OUT} = 4.0 V	A ₀ - A ₇	1, 2, 3	All		80	μA
			B ₀ - B ₇	1, 2, 3	All		200	μA
Off state output current low, A ₀ - A ₇ , B ₀ - B ₇	I _{OZL}	V _{CC} = 5.5 V, CD = 2.0 V, V _{OUT} = 0.4 V		1, 2, 3	All		-200	μA
Supply current	I _{CC}	V _{CC} = 5.5 V, CD = 2.0 V, T/ \bar{R} = 0.4 V	V _{IN} = 0.4 V	1, 2, 3	01		100	mA
			V _{IN} = 2.0 V	1, 2, 3	02		100	mA
		V _{CC} = 5.5 V, CD = 0.4 V, T/ \bar{R} = 2.0 V	V _{IN} = 0.4 V	1, 2, 3	01		140	mA
			V _{IN} = 2.0 V	1, 2, 3	02		150	mA
Propagation delay time, input B port to output A port	t _{PHL1}	CD = T/ \bar{R} = 0.4 V, R ₁ = 1 kΩ, R ₂ = 5 kΩ, C ₁ = 30 pF (See figure 4)		9	01		18	ns
				<u>2/</u>	02		12	ns
				9, 10, 11	01		24	ns
				<u>3/</u>	02		19	ns
	t _{PLH1}			9	01		18	ns
				<u>2/</u>	02		16	ns
				9, 10, 11	01		24	ns
				<u>3/</u>	02		23	ns
Disable time, CD to A port	t _{PLZ1}	T/ \bar{R} = 0.4 V, R ₅ = 1 kΩ, C ₄ = 15 pF (See figure 6)	B ₀ - B ₇ = 0.4 V, S ₃ = 1	9 <u>2/</u>	All		15	ns
				9, 10, 11	All		21	ns
	t _{PHZ1}		B ₀ - B ₇ = 2.4 V, S ₃ = 0	9 <u>2/</u>	All		15	ns
				9, 10, 11	All		21	ns

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C unless otherwise specified		Group A subgroups	Device type	Limits		Unit	
						Min	Max		
Enable time, CD to A port	t _{PZL1}	C ₄ = 30 pF, T/R̄ = 0.4 V, (See figure 6)	B ₀ - B ₇ = 0.4 V, S ₃ = 1, R ₅ = 1 kΩ	9 2/	All		25	ns	
				9, 10, 11 3/	All		33	ns	
	t _{PZH1}	4/	B ₀ - B ₇ = 2.4 V, S ₃ = 0, R ₅ = 5 kΩ	9 2/	All		25	ns	
				9, 10, 11 3/	All		33	ns	
Propagation delay time, input A port to output B port	t _{PHL2}	CD = 0.4 V, T/R̄ = 2.4 V, (See figure 4)	R ₁ = 100 Ω, R ₂ = 1 kΩ, C ₁ = 300 pF	9 2/	01		23	ns	
					02		18	ns	
				9, 10, 11 3/	01		34	ns	
					02		29	ns	
				9 2/	R ₁ = 667 Ω, R ₂ = 5 kΩ, C ₁ = 45 pF	01		18	ns
						02		12	ns
	9, 10, 11 3/	01		25	ns				
		02		19	ns				
	t _{PLH2}	4/	R ₁ = 100 Ω, R ₂ = 1 kΩ, C ₁ = 300 pF	9 2/	01		23	ns	
					02		20	ns	
				9, 10, 11 3/	01		34	ns	
					02		30	ns	
9 2/				R ₁ = 667 Ω, R ₂ = 5 kΩ, C ₁ = 45 pF	01		18	ns	
					02		14	ns	
9, 10, 11 3/	01		25	ns					
	02		22	ns					
Disable time, CD to B port	t _{PLZ2}	T/R̄ = 2.4 V, R ₅ = 1 kΩ, C ₄ = 15 pF, (See figure 6)	A ₀ - A ₇ = 0.4 V, S ₃ = 1	9 2/	All		18	ns	
				9, 10, 11 3/	All		26	ns	
	t _{PHZ2}	4/	A ₀ - A ₇ = 2.4 V, S ₃ = 0	9 2/	All		15	ns	
				9, 10, 11 3/	All		21	ns	

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C unless otherwise specified		Group A subgroups	Device type	Limits		Unit
						Min	Max	
Enable time, CD to B port	t _{PZL2}	A ₀ - A ₇ = 0.4 V, T/ \bar{R} = 2.4 V, S ₃ = 1, (See figure 6) 4/	R ₅ = 100 Ω, C ₄ = 300 pF	9 2/	All		35	ns
				9, 10, 11 3/	All		43	ns
				9 2/	All		22	ns
				9, 10, 11 3/	All		30	ns
	t _{PZH2}	A ₀ - A ₇ = 2.4 V, T/ \bar{R} = 2.4 V, S ₃ = 0, (See figure 6) 4/	R ₅ = 1 kΩ, C ₄ = 300 pF	9 2/	All		35	ns
				9, 10, 11 3/	All		43	ns
				9 2/	All		22	ns
				9, 10, 11 3/	All		30	ns
Propagation delay time, from transmit mode to receive, T/ \bar{R} to A port	t _{TRL}	A port, S ₂ = 1, C ₂ = 30 pF; CD = 0.4 V, R ₃ = 1 kΩ (See figure 5) 4/	9 2/	01		38	ns	
				02		33	ns	
			9, 10, 11 3/	01		48	ns	
				02		43	ns	
			B port, S ₁ = 0, R ₄ = 100 Ω; C ₃ = 5 pF (See figure 5) 4/	9 2/	01		38	ns
					02		33	ns
				9, 10, 11 3/	01		48	ns
					02		43	ns
	t _{TRH}	A port, S ₂ = 0, C ₂ = 30 pF; CD = 0.4 V, R ₃ = 5 kΩ (See figure 5) 4/	9 2/	01		38	ns	
				02		33	ns	
			9, 10, 11 3/	01		48	ns	
				02		43	ns	
			B port, S ₁ = 1, R ₄ = 100 Ω; C ₃ = 5 pF (See figure 5) 4/	9 2/	01		38	ns
					02		33	ns
				9, 10, 11 3/	01		48	ns
					02		43	ns

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Propagation delay time, from transmit mode to receive, T/R to B port	t _{RTL}	A port, S ₂ = 0, C ₂ = 5 pF; CD = 0.4 V, R ₃ = 300 Ω (See figure 5) 4/	9 2/	01		40	ns
				02		35	ns
			9, 10, 11 3/	01		51	ns
				02		47	ns
			9 2/	01		40	ns
				02		35	ns
	B port, S ₁ = 1, R ₄ = 100 Ω; C ₃ = 300 pF (See figure 5) 4/	9, 10, 11 3/	01		51	ns	
			02		47	ns	
		9 2/	01		40	ns	
			02		35	ns	
		9, 10, 11 3/	01		51	ns	
			02		47	ns	
t _{RTH}	A port, S ₂ = 1, C ₂ = 5 pF; CD = 0.4 V, R ₃ = 300 Ω (See figure 5) 4/	9 2/	01		40	ns	
			02		35	ns	
		9, 10, 11 3/	01		51	ns	
			02		47	ns	
		9 2/	01		40	ns	
			02		35	ns	
9, 10, 11 3/	01		51	ns			
	02		47	ns			

- 1/ Not more than one output should be shorted at a time and the duration of the short circuit condition should not exceed one second.
 2/ V_{CC} = 5.0 V.
 3/ V_{CC} = 4.5 V to 5.5 V.
 4/ All ac loads are correlated from load of 50 pF during test.

**STANDARD
MICROCIRCUIT DRAWING**
 DEFENSE SUPPLY CENTER COLUMBUS
 COLUMBUS, OHIO 43218-3990

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Device types	01	02
Case outlines	R and 2	R and 2
Terminal number	Terminal symbols	
1	A ₀	A ₀
2	A ₁	A ₁
3	A ₂	A ₂
4	A ₃	A ₃
5	A ₄	A ₄
6	A ₅	A ₅
7	A ₆	A ₆
8	A ₇	A ₇
9	CD	CD
10	GND	GND
11	T/ \bar{R}	T/ \bar{R}
12	B ₇	B ₇
13	B ₆	B ₆
14	B ₅	B ₅
15	B ₄	B ₄
16	B ₃	B ₃
17	B ₂	B ₂
18	B ₁	B ₁
19	B ₀	B ₀
20	V _{CC}	V _{CC}

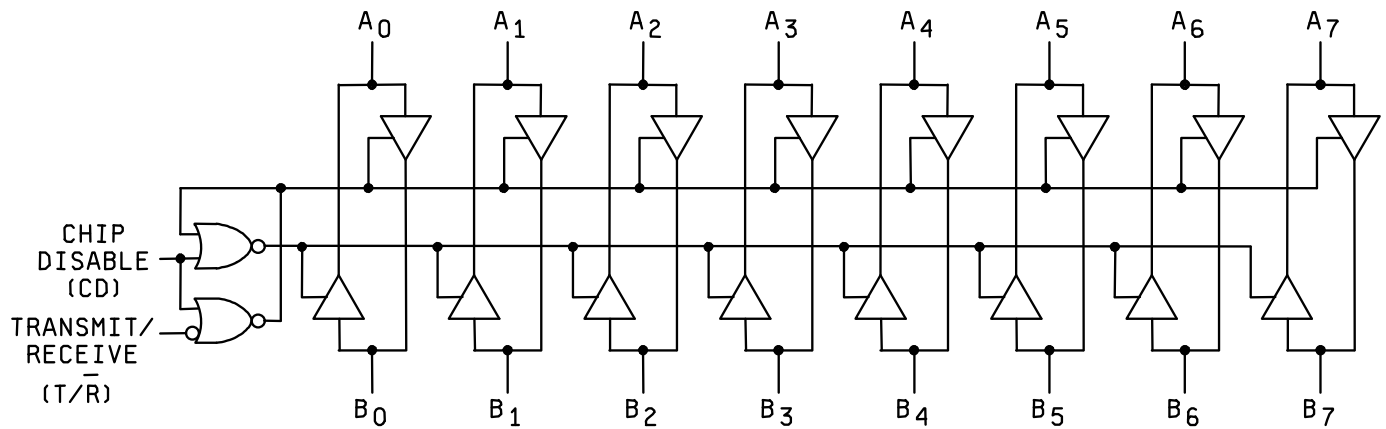
FIGURE 1. Terminal connections.

Inputs	Conditions		
Chip Disable	L	L	H
Transmit/Receive	L	H	X
A Port	Out	In	Z
B Port	In	Out	Z

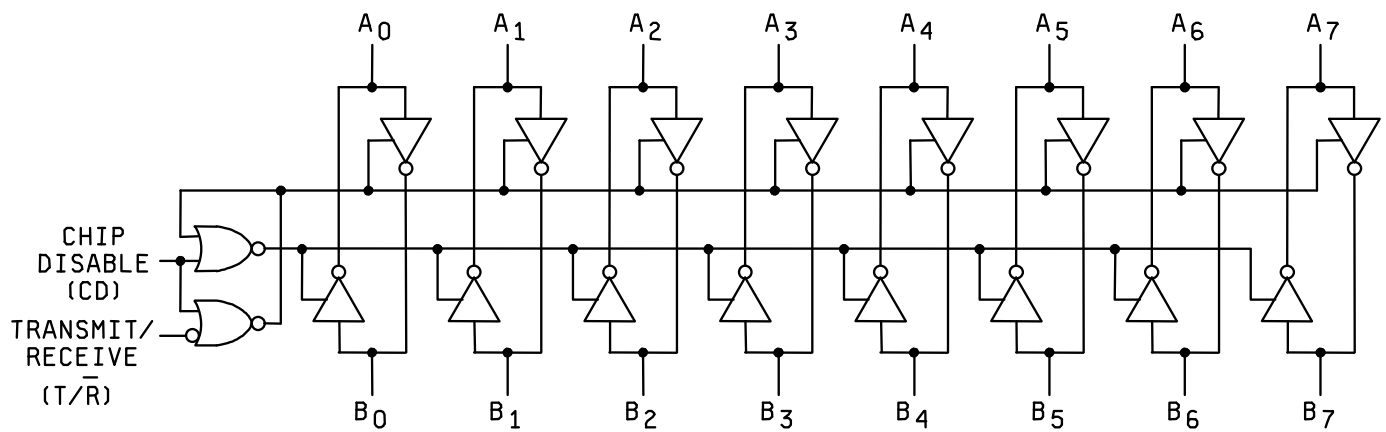
H = high level
L = low level
Z = high impedance state
X = irrelevant

FIGURE 2. Truth table.

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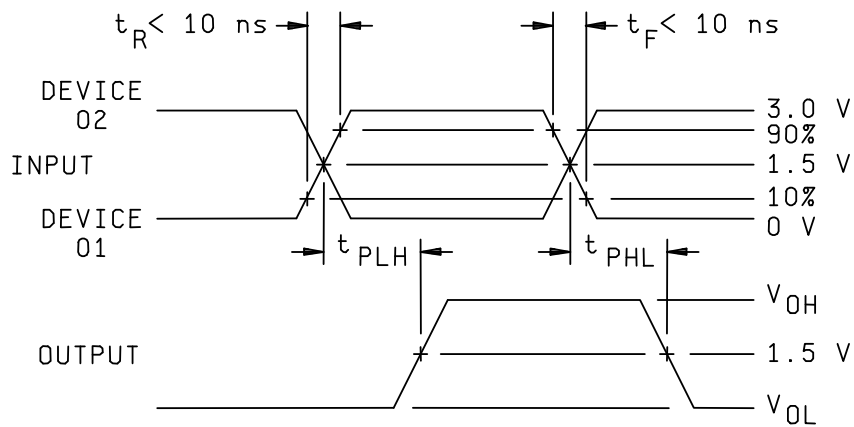
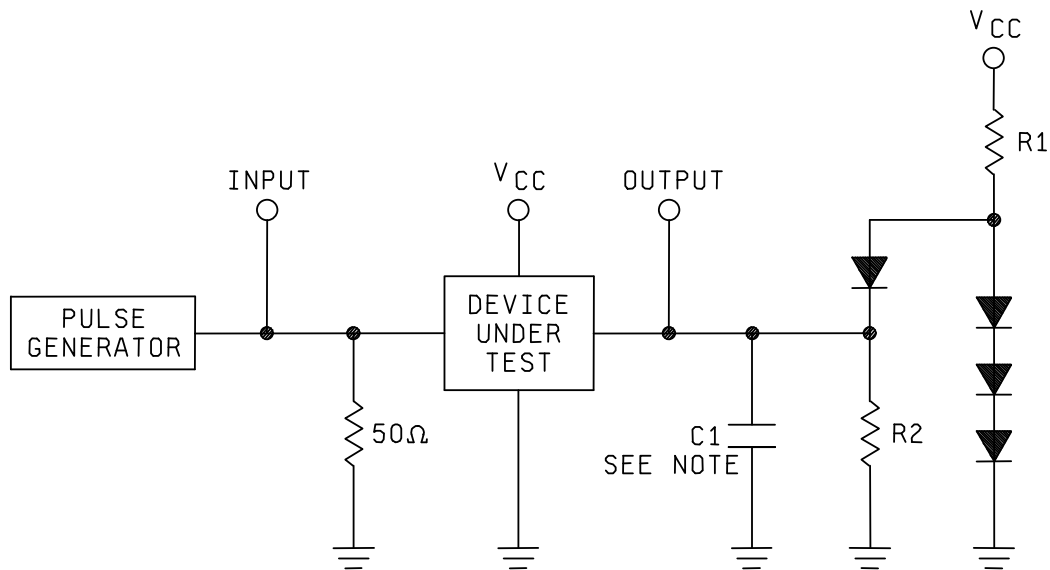
DEVICE 01 (NONINVERTING)



DEVICE 02 (INVERTING)

FIGURE 3. Logic diagram.

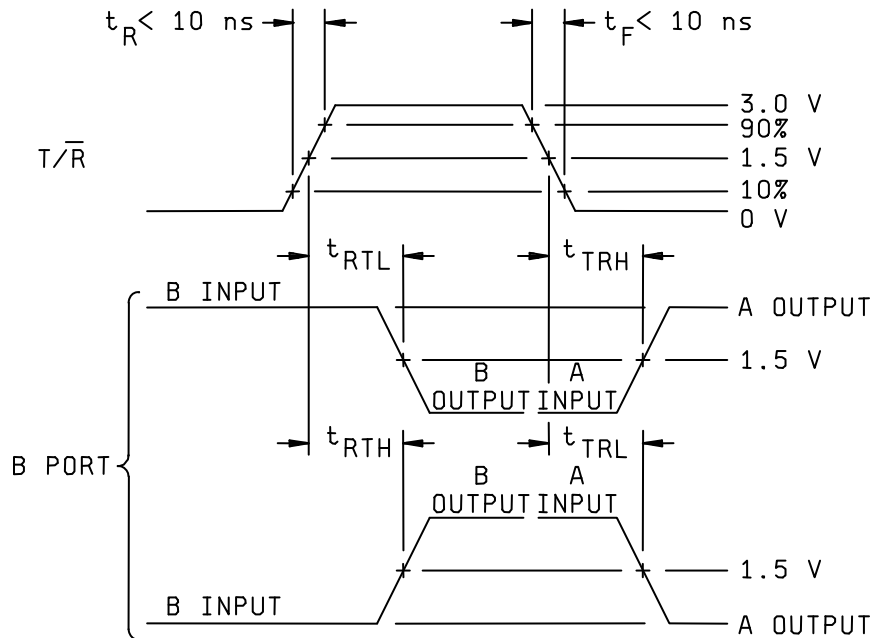
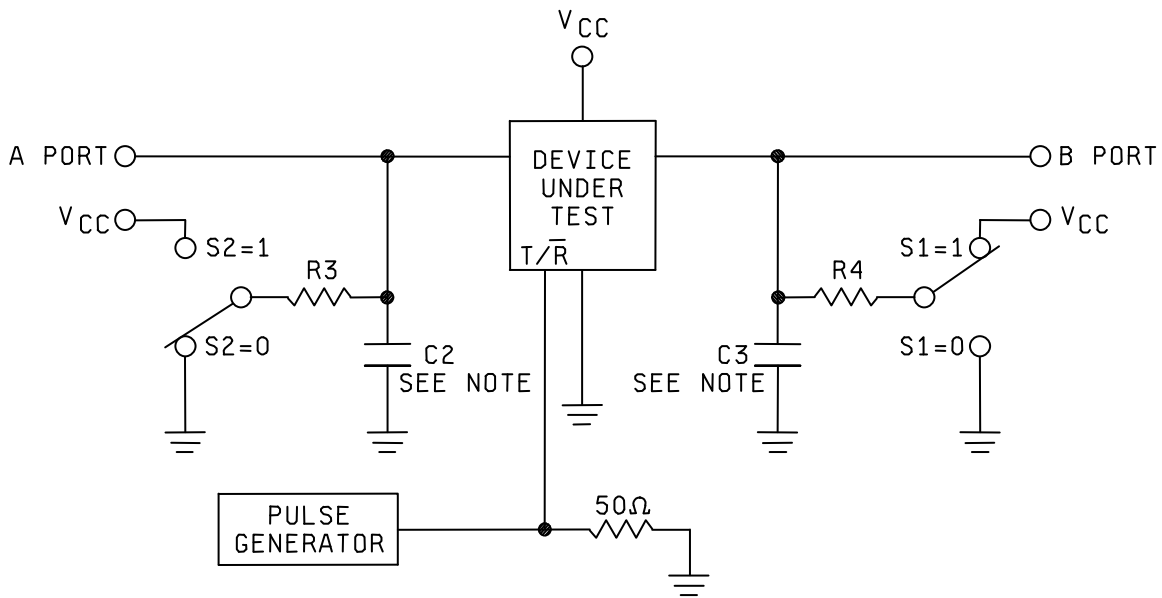
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NOTE: C1 includes test fixture capacitance.

FIGURE 4. Test circuit and switching waveforms - From A/B port to B/A port.

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NOTE: C2 and C3 include test fixture capacitance.

FIGURE 5. Test circuit and switching waveforms - From T/\bar{R} to A or B port.

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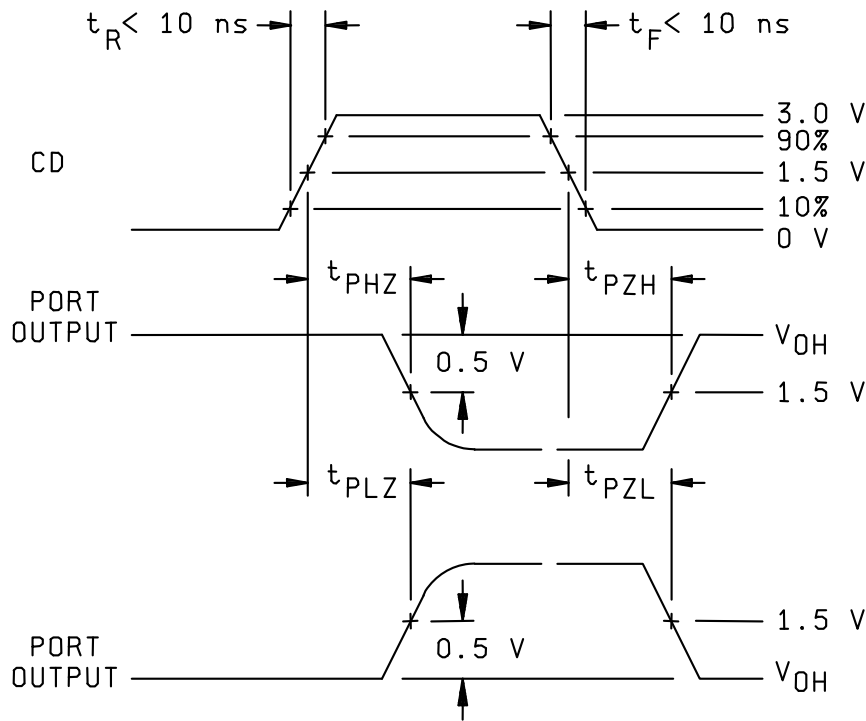
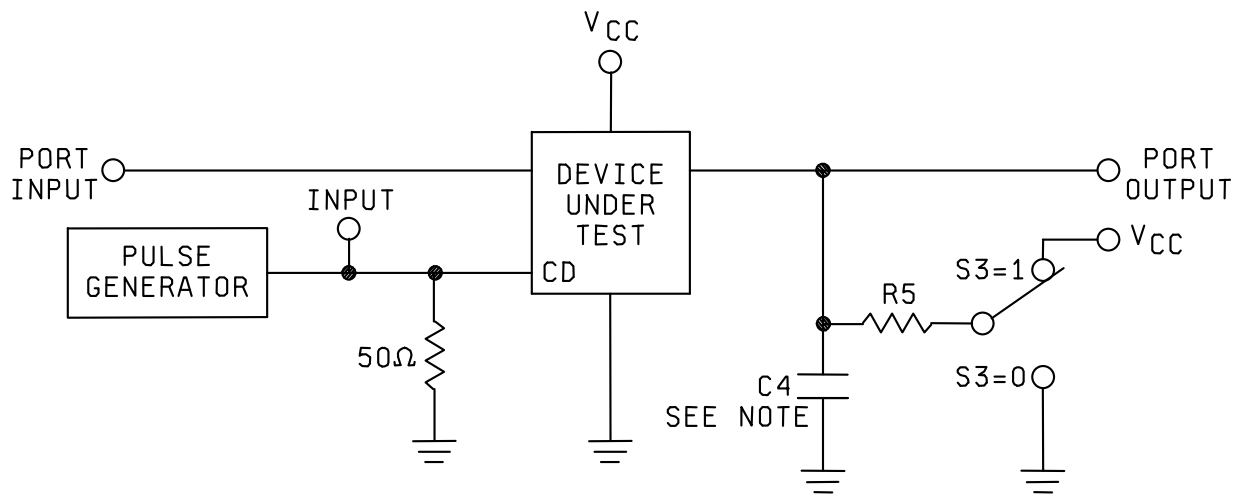
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5962-86723

REVISION LEVEL
D

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NOTE: C4 includes test fixture capacitance, port input is in a fixed logical condition.

FIGURE 6. Test circuit and switching waveforms - From CD to A or B port.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	- - -
Final electrical test parameters (method 5004)	1*, 2, 3, 7, 8, 9
Group A test requirements (method 5005)	1, 2, 3, 7, 8, 9, 10**, 11**
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

* PDA applies to subgroup 1.

** Subgroups 10 and 11, if not tested, shall be guaranteed to the limits specified in table I.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 4, 5, and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroups 7 and 8 shall include verification of the truth table.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}\text{C}$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.4 Record of users. Military and industrial users shall inform Defense Supply Center Columbus (DSCC) when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.

6.5 Comments. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0547.

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

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STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 09-03-12

Approved sources of supply for SMD 5962-86723 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DSCC maintains an online database of all current sources of supply at <http://www.dscclia.mil/Programs/Smcr/>.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-8672301RA	3V146	2947/BRA
	0DKS7	GEM07501QRA
	<u>3</u> /	AM2947/BRA
5962-8672301RC	0DKS7	GEM07501QRC
5962-86723012A	3V146	2947/B2A
	0DKS7	GEM07501Q2A
	<u>3</u> /	AM2947/B2A
5962-86723012C	0DKS7	GEM07501Q2C
5962-8672302RA	3V146	2946/BRA
	0DKS7	GEM13302BRA
	<u>3</u> /	AM2947/BRA
5962-8672302RC	0DKS7	GEM13302BRC
5962-86723022A	3V146	2946/B2A
	0DKS7	GEM13302B2A
	<u>3</u> /	AM2947/B2A
5962-86723022C	0DKS7	GEM13302B2C

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.
- 2/ **Caution.** Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- 3/ No current source.

Vendor CAGE
number

Vendor name
and address

3V146

Rochester Electronics
16 Malcom Hoyt Drive
Newburyport, MA 01950

0DKS7

Sarnoff, David Research Center
201 Washington Road
Princeton, NJ 08540-5300

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.